

Hall Effect Micro Switch IC

Features

- **Micro Power Operation for Battery Applications**
- **Chopper Stabilized Amplifier**
- **Independent of North or South Pole Magnet, Easy for Manufacture**
- **Small Size Package**
- **Lead Free and Green Devices Available (RoHS Compliant)**

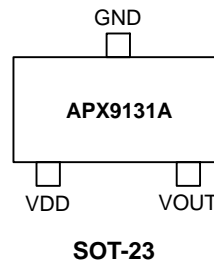
Applications

- **Micro Switch**
- **Handheld Wireless Application Wake Up Switch**
- **Clamp Shell Type Application Switch**
- **Magnet Switch in Low Duty Cycle Applications**

General Description

The APX9131A, integrated circuit, is an ultra-sensitive, pole independent Hall-effect switch with a latched digital output. A 2.5 volt to 3.5 volt operation and an unique clocking scheme reduce the average operating power requirements, either a north or south pole of sufficient flux will turn the output on; in the absence of a magnetic field, the output is off. The polarity independence and minimal power requirement allow this device to be easily replaced reed switch for superior for signal conditioning. Advanced CMOS processing is used to take advantage of low-voltage and low-power requirements, SOT-23 package provided a optimized package for most applications.

Pin Configuration



Ordering and Marking Information

<p>APX9131A □□-□□□</p> <div style="margin-left: 20px;"> <p>└─ Assembly Material</p> <p>└─ Handling Code</p> <p>└─ Temperature Range</p> <p>└─ Package Code</p> </div>	<p>Package Code A : SOT-23</p> <p>Operating Ambient Temperature Range I : -40 to 85 °C</p> <p>Handling Code TR : Tape & Reel</p> <p>Assembly Material G : Halogen and Lead Free Device</p>
<p>APX9131A A: X31X</p>	<p>X - Date Code</p>

Note: ANPEC lead-free products contain molding compounds/die attach materials and 100% matte tin plate termination finish; which are fully compliant with RoHS. ANPEC lead-free products meet or exceed the lead-free requirements of IPC/JEDEC J-STD-020C for MSL classification at lead-free peak reflow temperature. ANPEC defines "Green" to mean lead-free (RoHS compliant) and halogen free (Br or Cl does not exceed 900ppm by weight in homogeneous material and total of Br and Cl does not exceed 1500ppm by weight).

ANPEC reserves the right to make changes to improve reliability or manufacturability without notice, and advise customers to obtain the latest version of relevant information to verify before placing orders.

Absolute Maximum Ratings ($T_A = 25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Rating	Unit
V_{DD}	Supply Voltage	5	V
V_{OUT}	Output Voltage	5	V
T_J	Junction Temperature Range	150	°C
T_{STG}	Storage Temperature Range	-65 to +150	

Electrical Characteristics ($T_A = 25^\circ\text{C}$, $V_{DD} = 3\text{V}$ unless otherwise noted)

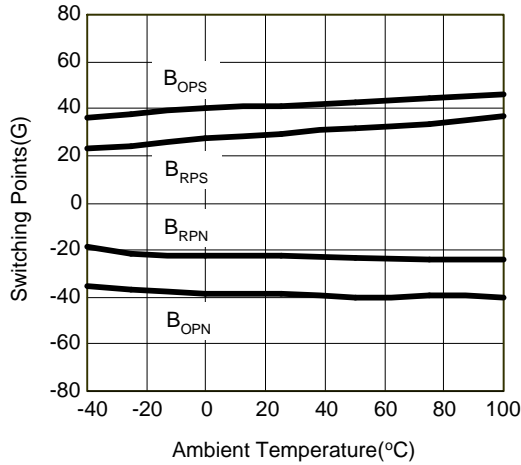
Symbol	Characteristic	Test Conditions	APX9131A			Unit
			Min.	Typ.	Max.	
V_{DD}	Supply Voltage Range	Operating	2.5	-	3.5	V
I_{DD}	Supply Current	Average	-	5	10	μA
		Awake	-	1.2	2	mA
		Sleep	-	2	8	μA
I_{OFF}	Output Leakage Current	$V_{OUT} = 3.5\text{V}$, $B_{RPN} < B < B_{RPS}$	-	-	1.0	μA
V_{OL}	Output Low Voltage	$I_{SINK} = 1\text{mA}$	-	20	40	mV
t_{wake}	Wake Up Time		-	180	-	μs
t_{period}	Period		-	60	-	mS
d.c.	Duty Cycle		-	0.3	-	%
f_c	Chopping Frequency		-	11	-	kHz

Magnetic Characteristics ($T_A = 25^\circ\text{C}$, $V_{DD} = 3\text{V}$ unless otherwise noted)

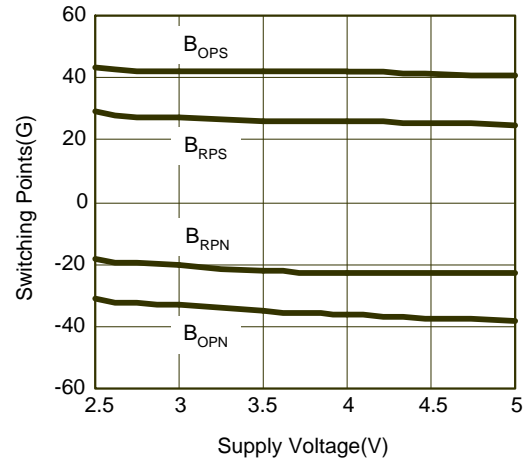
Symbol	Characteristic	Test Conditions	APX9131A			Unit
			Min.	Typ.	Max.	
B_{OPS}	Operate Points		20	40	60	G
B_{OPN}			-60	-40	-20	G
B_{RPS}	Release Points		10	25	50	G
B_{RPN}			-50	-25	-10	G
B_{hys}	Hysteresis		-	15	-	G

Typical Operating Characteristics

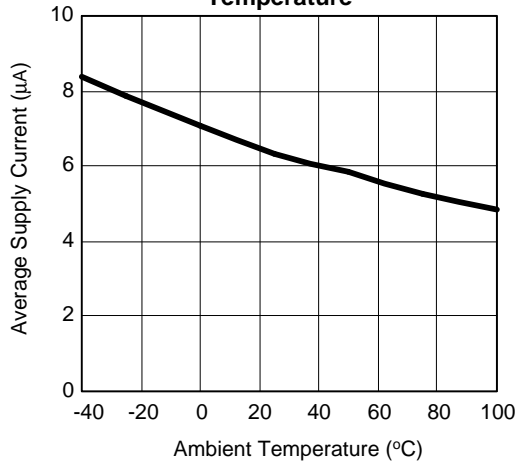
Switching Points vs. Ambient Temperature



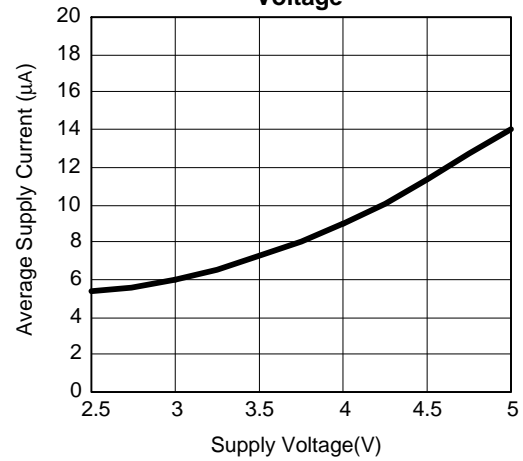
Switching Points vs. Supply Voltage



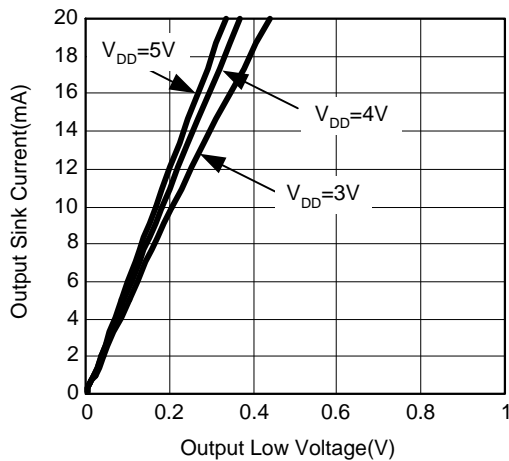
Average Supply Current vs. Ambient Temperature



Average Supply Current vs. Supply Voltage

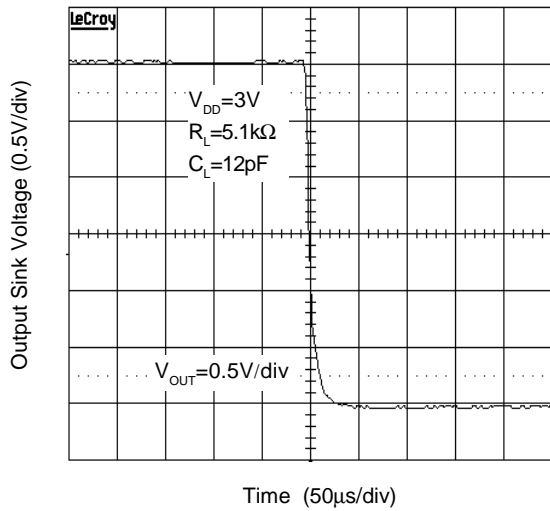


Output Sink Current vs. Output Low Voltage

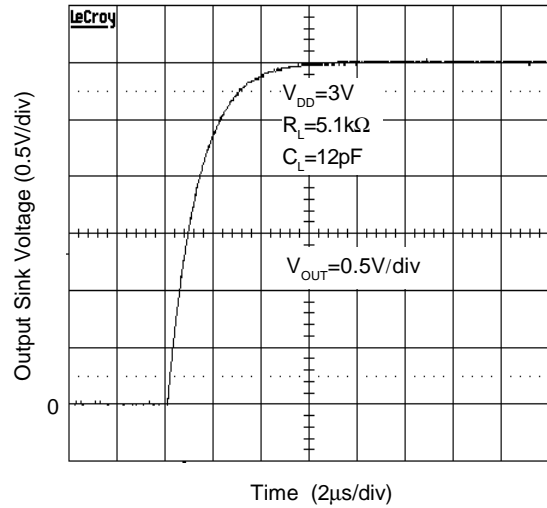


Operating Waveforms

Output Switch Waveform



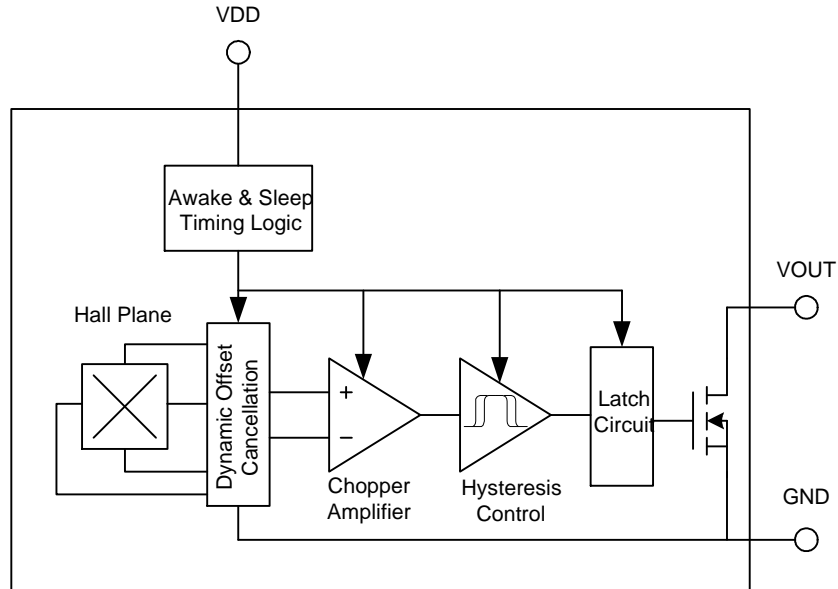
Output Switch Waveform



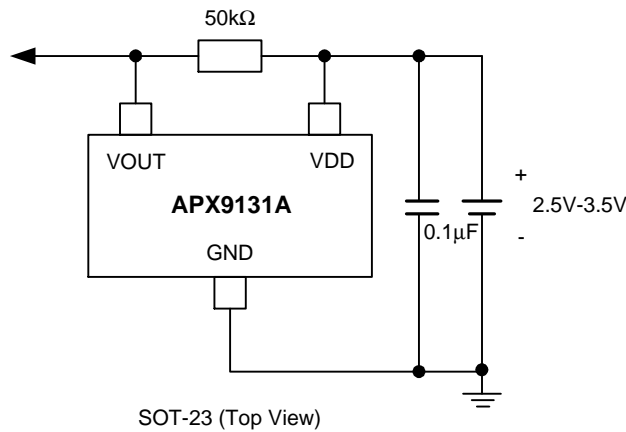
Pin Description

PIN		FUNCTION
NO.	NAME	
1	VDD	Power Input
2	VOUT	When a magnetic field enters the hall element and exceeds the operate point BOPS (or less than BOPN), the output turns on (output is low). When the magnetic field is below the release point BRPS (or above BRPN), the output turns off (output is high). It is designed with open drain configuration and connecting a pull up resistor from VOUT to VDD is necessary. It cannot be floating.
3	GND	Ground Connection.

Block Diagram



Typical Application Circuit



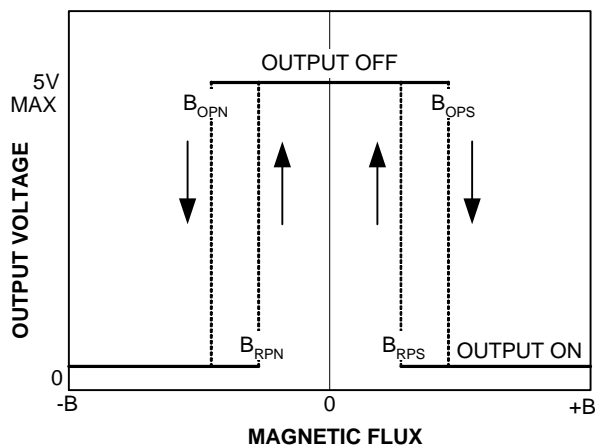
Function Description

Operation

The output of APX9131A switches low (turns on) when in presence of strong flux density facing the marked side of package exceeds the operate point B_{OPS} (or is less than B_{OPN}). After turn-on, the output is capable of sinking up to 1mA and the output voltage is low (turns on). In absence of flux density below the release point B_{RPS} (or increased above B_{RPN}), the APX9131A output switches high (turns off). The difference in the magnetic operated and released point is the hysteresis (B_{hys}) of the device. This built-in hysteresis allows clean switching of the output even in the presence of external mechanical bouncing vibration and electrical noise.

Chopper Stabilized Technique

The chopper stabilized technique cancels the mismatching of the hall element, the amplifier offset voltage and temperature sensitive drift by the dynamic offset cancellation and switched capacitor technique. This technique produces devices have an extremely stable Hall output voltage, therefore, the magnetic switch points are stable.



Pole-Independent

The pole-independent sensing technique allows for operation with either a north or south pole magnet orientation, enhancing the manufacturability of the device. The state-of-the-art technology provides the same output polarity for either pole in presence.

Awake & Sleep

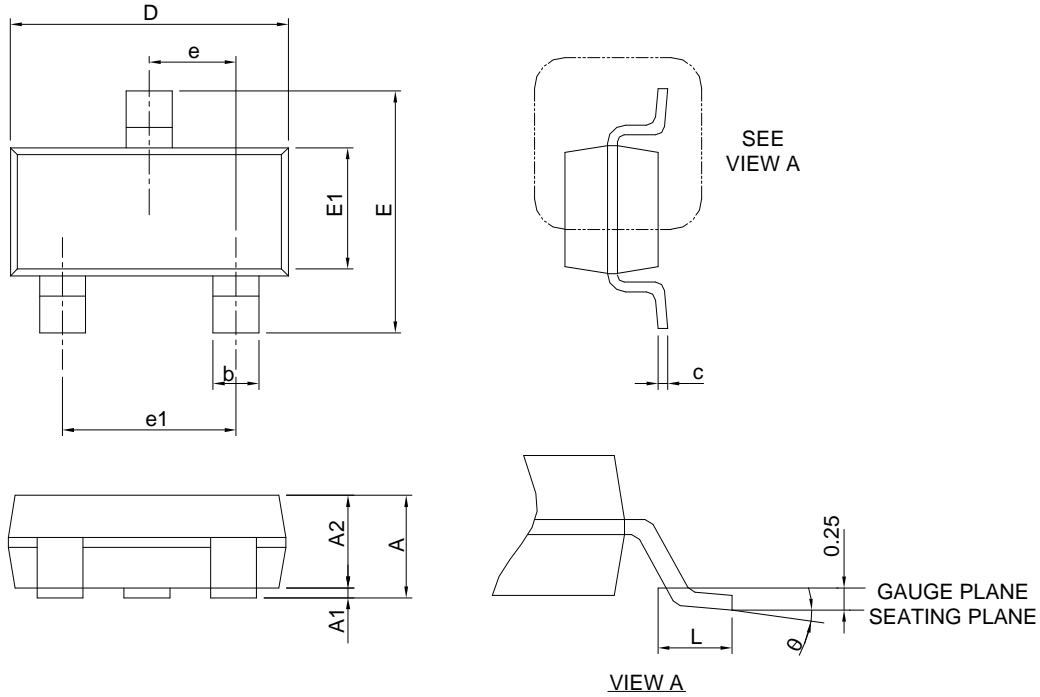
Internal awake & sleep timing block circuit activates the sensor for 180 μ s and deactivates it for the remainder of the period (60ms). A short "awake" time allows for stabilization prior to the sensor sampling and data latching on the falling edge of the timing pulse. While in sleep cycle, the output is latched in its previous state.

Application Information

It is strongly recommended that an external bypass capacitor be connected (in close to the Hall sensor) between the supply and the ground of the device to reduce both external noise and noise generated by the chopper-stabilization technique. This is especially true due to the relatively high impedance of battery supplies. The output is an open drain output, it must be connected a pull-up resistor to a supply voltage which is lower than 5V, connect a 50k Ω resistor to VDD in common use.

Package Information

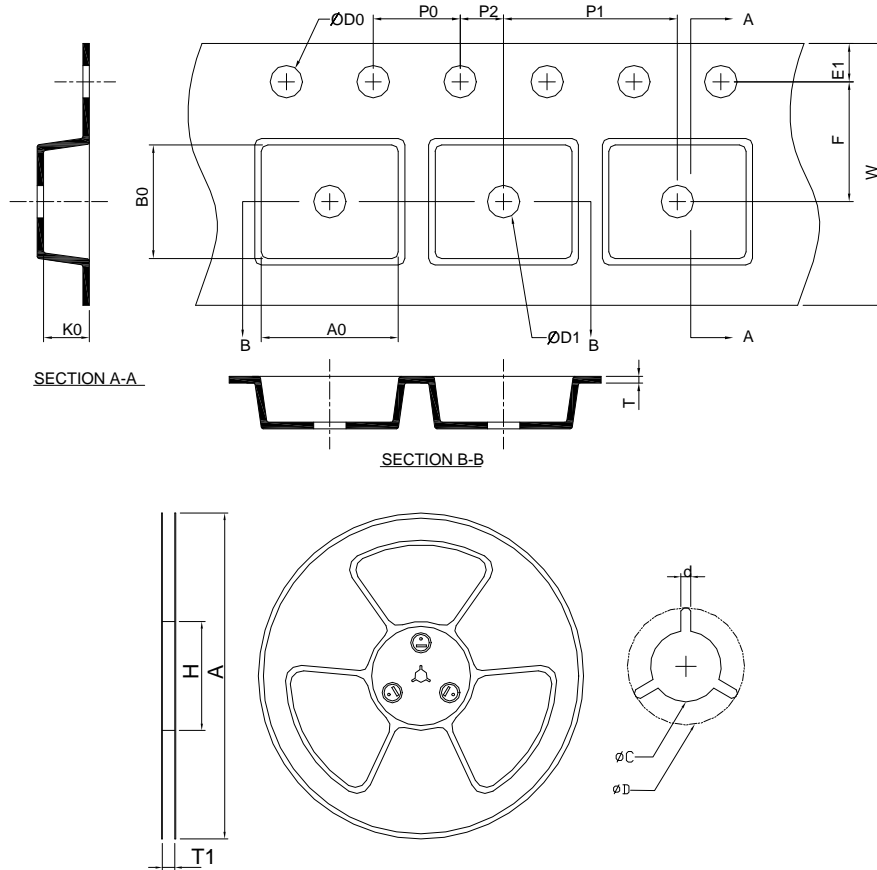
SOT-23



SYMBOL	SOT-23			
	MILLIMETERS		INCHES	
	MIN.	MAX.	MIN.	MAX.
A		1.45		0.057
A1	0.00	0.15	0.000	0.006
A2	0.90	1.30	0.035	0.051
b	0.30	0.50	0.012	0.020
c	0.08	0.22	0.003	0.009
D	2.70	3.10	0.106	0.122
E	2.60	3.00	0.102	0.118
E1	1.40	1.80	0.055	0.071
e	0.95 BSC		0.037 BSC	
e1	1.90 BSC		0.075 BSC	
L	0.30	0.60	0.012	0.024
θ	0°	8°	0°	8°

Note : Dimension D and E1 do not include mold flash, protrusions or gate burrs. Mold flash, protrusion or gate burrs shall not exceed 10 mil per side.

Carrier Tape & Reel Dimensions



Application	A	H	T1	C	d	D	W	E1	F
SOT-23	178.0 ±0.00	50 MIN.	8.4+2.00 -0.00	13.0+0.50 -0.20	1.5 MIN.	20.2 MIN.	8.0 ±0.30	1.75 ±0.10	3.5 ±0.05
	P0	P1	P2	D0	D1	T	A0	B0	K0
	4.0 ±0.10	4.0 ±0.10	2.0 ±0.05	1.5+0.10 -0.00	1.0 MIN.	0.6+0.00 -0.40	3.20 ±0.20	3.10 ±0.20	1.50 ±0.20

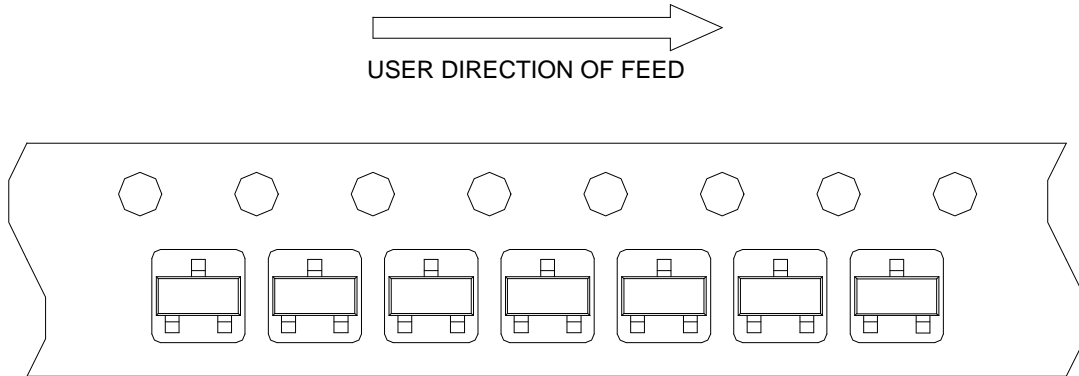
(mm)

Devices Per Unit

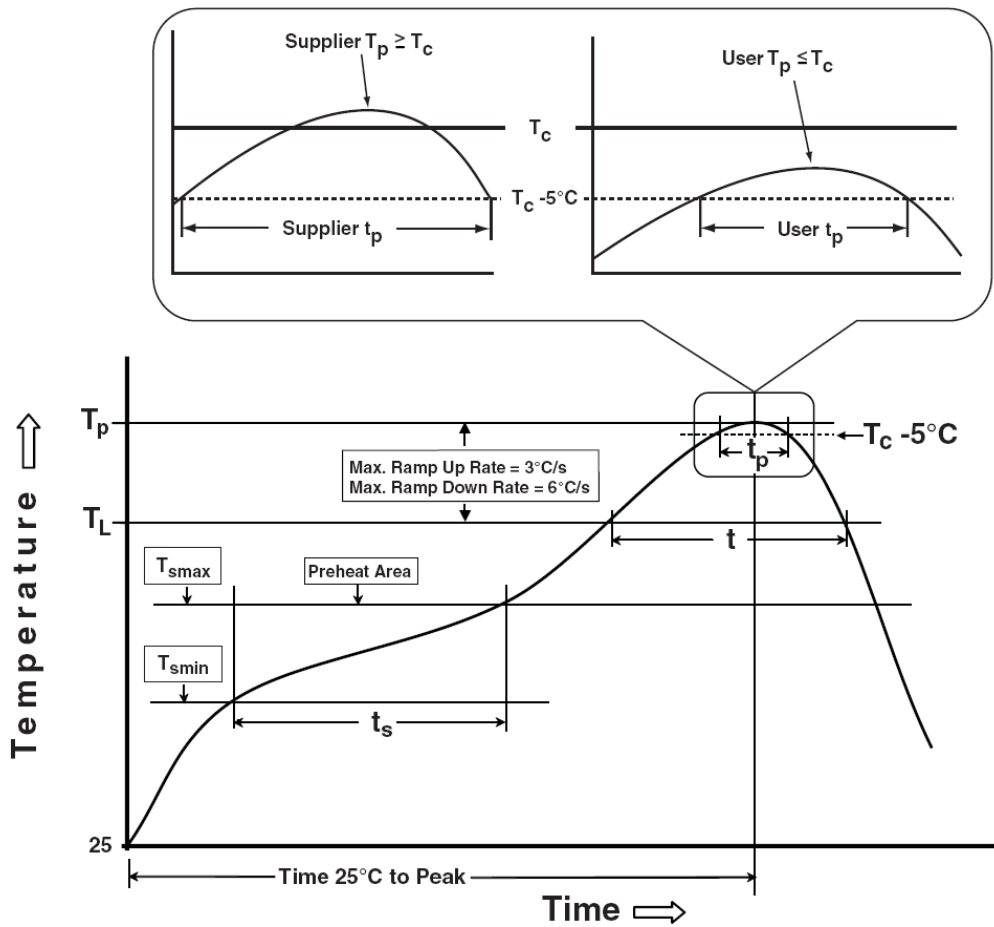
Package Type	Unit	Quantity
SOT-23	Tape & Reel	3000

Taping Direction Information

SOT-23



Classification Profile



Classification Reflow Profiles

Profile Feature	Sn-Pb Eutectic Assembly	Pb-Free Assembly
Preheat & Soak Temperature min (T_{smin}) Temperature max (T_{smax}) Time (T_{smin} to T_{smax}) (t_s)	100 °C 150 °C 60-120 seconds	150 °C 200 °C 60-120 seconds
Average ramp-up rate (T_{smax} to T_p)	3 °C/second max.	3°C/second max.
Liquidous temperature (T_L) Time at liquidous (t_L)	183 °C 60-150 seconds	217 °C 60-150 seconds
Peak package body Temperature (T_p)*	See Classification Temp in table 1	See Classification Temp in table 2
Time (t_p)** within 5°C of the specified classification temperature (T_c)	20** seconds	30** seconds
Average ramp-down rate (T_p to T_{smax})	6 °C/second max.	6 °C/second max.
Time 25°C to peak temperature	6 minutes max.	8 minutes max.
* Tolerance for peak profile Temperature (T_p) is defined as a supplier minimum and a user maximum. ** Tolerance for time at peak profile temperature (t_p) is defined as a supplier minimum and a user maximum.		

Table 1. SnPb Eutectic Process – Classification Temperatures (T_c)

Package Thickness	Volume mm ³ <350	Volume mm ³ ≥350
<2.5 mm	235 °C	220 °C
≥2.5 mm	220 °C	220 °C

Table 2. Pb-free Process – Classification Temperatures (T_c)

Package Thickness	Volume mm ³ <350	Volume mm ³ 350-2000	Volume mm ³ >2000
<1.6 mm	260 °C	260 °C	260 °C
1.6 mm – 2.5 mm	260 °C	250 °C	245 °C
≥2.5 mm	250 °C	245 °C	245 °C

Reliability Test Program

Test item	Method	Description
SOLDERABILITY	JESD-22, B102	5 Sec, 245°C
HOLT	JESD-22, A108	1000 Hrs, Bias @ 125°C
PCT	JESD-22, A102	168 Hrs, 100%RH, 2atm, 121°C
TCT	JESD-22, A104	500 Cycles, -65°C~150°C
ESD	MIL-STD-883-3015.7	VHBM 2KV, VMM 200V
Latch-Up	JESD 78	10ms, 1 _{tr} 100mA

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